## 6-PIN DIP, HIGH ISOLATION VOLTAGE 1-ch Optical Coupled MOS FET

## DESCRIPTION

The PS7342-1A and PS7342L-1A are solid state relays containing GaAs LEDs on the light emitting side (input side) and MOS FETs on the output side.

They are suitable for analog signal control because of their low offset and high linearity.
The PS7342L-1A has a surface mount type lead.

## * FEATURES

- High isolation voltage (BV=3 750 Vr.m.s.)
- 1 channel type (1 a output)
- Low LED Operating Current ( $\mathrm{IF}=2 \mathrm{~mA}$ )
- Designed for AC/DC switching line changer
- Small package (6-pin DIP)
- Low offset voltage
- PS7342L-1A: Surface mount type
- UL approved: File No. E72422 (S)
- BSI approved: No. 8252/8253
- CSA approved: No. CA 101391


## APPLICATIONS

- Exchange equipment
- Measurement equipment
- FA/OA equipment

PACKAGE DIMENSIONS (in millimeters)


## * ORDERING INFORMATION

| Part Number | Package | Packing Style | Application Part Number ${ }^{*}$ |
| :--- | :--- | :--- | :--- |
| PS7342-1A | 6-pin DIP | Magazine case 50 pcs | PS7342-1A |
| PS7342L-1A |  |  | PS7342L-1A |
| PS7342L-1A-E3 |  |  |  |
| PS7342L-1A-E4 |  | Embossed Tape 1000 pcs/reel |  |

*1 For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS ( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise specified)

| Parameter |  |  | Symbol | Ratings | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Diode | Forward Current (DC) |  | $\mathrm{I}_{\mathrm{F}}$ | 50 | mA |
|  | Reverse Voltage |  | $V_{R}$ | 5.0 | V |
|  | Power Dissipation |  | PD | 50 | mW |
|  | Peak Forward Current ${ }^{* 1}$ |  | IfP | 1 | A |
| MOS FET | Break Down Voltage |  | V | 400 | V |
|  | Continuous <br> Load Current ${ }^{* 2}$ | Connection A | IL | 200 | mA |
|  |  | Connection B |  | 250 |  |
|  |  | Connection C |  | 400 |  |
|  | Pulse Load Current ${ }^{\text {³ }}$ (AC/DC Connection) |  | ILP | 400 | mA |
|  | Power Dissipation |  | PD | 560 | mW |
| Isolation Voltage ${ }^{*}$ |  |  | BV | 3750 | Vr.m.s. |
| Total Power Dissipation |  |  | $\mathrm{P}_{\text {t }}$ | 610 | mW |
| Operating Ambient Temperature |  |  | TA | -40 to +85 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature |  |  | $\mathrm{T}_{\text {stg }}$ | -40 to +125 | ${ }^{\circ} \mathrm{C}$ |

*1 PW = $100 \mu \mathrm{~s}$, Duty Cycle = $1 \%$
*2 Conditions: If $\geq 2 \mathrm{~mA}$. The following types of load connections are available.

*3 PW = 100 ms , 1 shot
*4 AC voltage for 1 minute at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{RH}=60 \%$ between input and output

RECOMMENDED OPERATING CONDITIONS (TA = $25^{\circ} \mathrm{C}$ )
$\star$

| Parameter | Symbol | MIN. | TYP. | MAX. | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: |
| LED Operating Current | $\mathrm{I}_{\mathrm{F}}$ | 2 | 10 | 20 | mA |
| LED Off Voltage | $\mathrm{V}_{\mathrm{F}}$ | 0 |  | 0.5 | V |

$\star$ ELECTRICAL CHARACTERISTICS (TA $=25^{\circ} \mathrm{C}$ )

| Parameter |  | Symbol | Conditions | MIN. | TYP. | MAX. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Diode | Forward Voltage | $V_{F}$ | $\mathrm{IF}=10 \mathrm{~mA}$ |  | 1.2 | 1.4 | V |
|  | Reverse Current | IR | $\mathrm{V}_{\mathrm{R}}=5 \mathrm{~V}$ |  |  | 5.0 | $\mu \mathrm{A}$ |
| MOS FET | Off-state Leakage Current | ILoff | V D $=400 \mathrm{~V}$ |  | 0.03 | 1.0 | $\mu \mathrm{A}$ |
|  | Output Capacitance | Cout | $\mathrm{V}_{\mathrm{D}}=0 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ |  | 225 |  | pF |
| Coupled | LED On-state Current | Ifon | $\mathrm{IL}=200 \mathrm{~mA}$ |  |  | 2.0 | mA |
|  | On-state Resistance | Ron1 | $\mathrm{IF}_{\mathrm{F}}=10 \mathrm{~mA}, \mathrm{IL}=10 \mathrm{~mA}$ |  | 6 | 10 | $\Omega$ |
|  |  | Ron2 | $\mathrm{I}_{\mathrm{F}}=10 \mathrm{~mA}, \mathrm{IL}=200 \mathrm{~mA}, \mathrm{t} \leq 10 \mathrm{~ms}$ |  |  |  |  |
|  | Turn-on Time ${ }^{\text {¹ }}$ | ton | $\mathrm{IF}_{F}=10 \mathrm{~mA}, \mathrm{~V}_{\mathrm{O}}=5 \mathrm{~V}, \mathrm{PW} \geq 10 \mathrm{~ms}$ |  | 1.2 | 2.5 | ms |
|  | Turn-off Time ${ }^{\text {¹ }}$ | toff |  |  | 0.06 | 0.2 |  |
|  | Isolation Resistance | Rı-o | $\mathrm{V}_{\mathrm{I}} \mathrm{O}=1.0 \mathrm{kV}$ dc | $10^{9}$ |  |  | $\Omega$ |
|  | Isolation Capacitance | Cı-o | $\mathrm{V}=0 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ |  | 1.1 |  | pF |

*1 Test Circuit for Switching Time

$\star$ TYPICAL CHARACTERISTICS ( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise specified)


FORWARD VOLTAGE vs.
AMBIENT TEMPERATURE


OFF-STATE LEAKAGE CURRENT vs. APPLIED VOLTAGE


MAXIMUM LORD CURRENT vs. AMBIENT TEMPERATURE


OUTPUT CAPACITANCE vs. APPLIED VOLTAGE


LORD CURRENT vs. LORD VOLTAGE


Load Voltage VL (V)

NORMALIZED ON-STATE RESISTANCE vs.

AMBIENT TEMPERATURE


TURN-ON TIME vs. FORWARD CURRENT


TURN-ON TIME DISTRIBUTION


ON-STATE RESISTANCE DISTRIBUTION


TURN-OFF TIME vs. FORWARD CURRENT


TURN-OFF TIME DISTRIBUTION



NORMALIZED TURN-OFF TIME vs. AMBIENT TEMPERATURE


Remark The graphs indicate nominal characteristics.

## ^ TAPING SPECIFICATIONS (in millimeters)

## Outline and Dimensions (Tape)



Tape Direction

$\rightarrow$

Outline and Dimensions (Reel)


Packing: 1000 pcs/reel


## RECOMMENDED SOLDERING CONDITIONS

(1) Infrared reflow soldering

- Peak reflow temperature
- Time of temperature higher than $210^{\circ} \mathrm{C}$
- Number of reflows
- Flux
$235{ }^{\circ} \mathrm{C}$ (package surface temperature)
30 seconds or less
One
Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of $0.2 \mathrm{Wt} \%$ is recommended.)

Recommended Temperature Profile of Infrared Reflow

(2) Dip soldering

- Temperature
- Time
$260^{\circ} \mathrm{C}$ or below (molten solder temperature)
10 seconds or less
- Number of times

One

- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of $0.2 \mathrm{Wt} \%$ is recommended.)


## (3) Cautions

- Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

- Products in dry pack

After opening the dry pack, solder the products within the valid storage period specified on the label on the dry pack.
[MEMO]

## CAUTION


#### Abstract

Within this device there exists GaAs (Gallium Arsenide) material which is a harmful substance if ingested. Please do not under any circumstances break the hermetic seal.


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